







LOW PROFILE SOCKETS SERIES

SPECIFICATIONS For complete specifications and recommended PCB layouts see www.samtec.com?CLP Insulator Material: Black Liquid Crystal Polymer Contact Material: Phosphor Bronze **Plating:** Sn or Au over 50µ" (1,27µm) Ni

Current Rating: 1.75A @ 80°C ambient Operating Temp Range: -55°C to +125°C Contact Resistance: 10 m Ω max Insertion Depth: Top Entry = (1,40mm) .055" minimum, Bottom Entry = (2,41mm) .095" minimum

plus board thickness DH Entry = (2,31mm) .091" to (2.67mm) .105" Insertion Force: (Single contact only) 3.8oz (1,05N) average Normal Force: 60 grams (0,59N) average Withdrawal Force:

(Single contact only) 2oz (0,56N) average Max Cycles: 100 with 10µ" (0,25µm) Au RoHS Compliant:

Processing:

Max Processing Temp: 230°C for 60 seconds, or 260°C for 20 seconds 3x Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (02-35) (0,15mm) .006" max (36-50)

ALSO AVAILABLE

Single row available. (Mates with FTS Series) Call Samtec.



Note: Some sizes, styles and options are non-standard. non-returnable.



